ASEDCIATION CONNECTING ELECTRONICS INDUSTRIES	omposition Dec 005. IPC, Bannockb nd Pan-American co	c <b>laration</b> ourn, Illinois. A opyright conver	Il rights reserved u ntions.	nder both	This docume level parts, th	ent is a declaration en declaration en	on of the substan acompasses all lo	ces within the man wer level material	ufacturer liste s for which the	d item. Note: e manufacture	if the item is an as r has engineering	sembly with low responsibility.	
	IPC Web Site for Information on IPC-1752 Standard Form T http://www.ipc.org/IPC-175x Distribution				e * Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mater				Materials and	ials and Mfg Information			
upplier Information													
ompany name*	Company unique ID			l	Unique ID Authority				Response Date*				
nsemi									2023-06-08				
Contact Name Title			Title - Contact			Phone - Contact*				Email - Contact*			
Product-Env-Stewards	Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com				
Authorized Representative* Ti			Title - Representative			Phone - Representative*			Emai	Email - Representative*			
roduct-Env-Stewards	Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com				
Requester Item Number	Requester Item Number Mfr Item		n Number Mfr Item Name			Effective Date	Version	Manufacturing	Site	Weight*	UOM	Unit Type	
	MC78M	MC78M08ABTG ANA 500MA		8V VREG		2023-06-08		MY1		1962.0	mg	Each	
Ianufacturing Proccess Info	rmation												
Terminal Plating / Grid Arr	Terminal Plating / Grid Array Material Termin		nal Base Alloy J-STD-020 MSL		L Rating	Peak Process Body Temperature		ature Max Time a	at Peak Tempe	erature Num	ber of Reflow Cyc	les	
Matte Tin (Sn) - annealed		CU Alloy NA		NA		0 C		30	sec	conds 3			
omments													
or more information regarding mat	erial composition	please refer to	page 3										

RoHS Material Composition Declaration				Declaration Type *	Detailed					
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Disobutyl phthalate (DIBP).									
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on informationprovided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, itsuppliers have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier's liability and the Company's remedies for issues that arise regarding information the Supplier provides in this form. In the absence of such written agreement, the warranty rights and/or remedies of Supplier's liability and the Company's remedies for uses that arise regarding information the Supplier provides in this form. In the absence of such w										
RoHS Declaration * 4 - Item(	s) does not contain RoHS restricted subst	ances per the definition above except for sele	ected exempt	ions Supplier Acceptance	* Accepted					
Exemption: 7a: Lead in high melting temp	erature type solders (i.e. lead based sol	der alloys containing 85% by weight or m	ore lead).							
Exemption List Version	EL-2011/534/EU									
Declaration Signature										
Instructions: Complete all of the required Requester) and click on Submit Form to h			e drop-dowi	a. This will display the signature area. Digita	lly sign the declaration (if required by the					
Supplier Digital Signature	astislav Drska	Le								

## Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	3.55	mg	Supplier	Silicon (Si)	7440-21-3		3.55	mg
Die Attach	82.92	mg	А	Lead (Pb)	7439-92-1	7a	78.774	mg
			Supplier	Tin (Sn)	7440-31-5		4.146	mg
Lead Frame	1299.13	mg	В	Nickel (Ni)	7440-02-0		0.6496	mg
			Supplier	Iron (Fe)	7439-89-6		1.2991	mg
			Supplier	Copper (Cu)	7440-50-8		1296.7916	mg
			Supplier	Phosphorus (P)	7723-14-0		0.3896	mg
Mold Compound-Black	543.9	mg		Phenolic Resin	proprietary data		32.634	mg
			Supplier	Ortho Cresol Novolac Resin	29690-82-2		54.39	mg
			Supplier	Carbon Black (C)	1333-86-4		2.7195	mg
			Supplier	Aluminum Hydroxide (Al(OH)3)	21645-51-2		40.7925	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		413.364	mg
Plating	31.13	mg	Supplier	Tin (Sn)	7440-31-5		31.13	mg
Wire Bond - Cu	1.37	mg	Supplier	Copper (Cu)	7440-50-8		1.37	mg

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3